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RESINOID POCKETED CUTOFF AND GRINDING WHEEL AND METHOD OF MAKING SAME

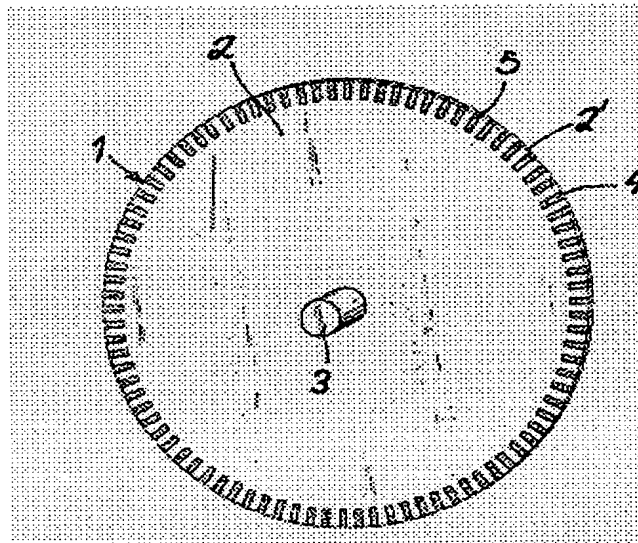
Patent number: JP50006079B
Publication date: 1975-03-10
Inventor:
Applicant:
Classification:
- international: B24D3/28; B24D5/06; B24D5/12
- european:
Application number: JP19690046504 19690614
Priority number(s): JP19690046504 19690614

Also published as:

 US3657845 (A)

Abstract not available for JP50006079B
Abstract of correspondent: **US3657845**

A cutoff or grinding wheel having a rotatable support, preferably in the form of a disk with a thickness of up to 1 mm, formed with a multiplicity of openings along the disk periphery. Diamond particles, with or without other abrasive, are incorporated in a resinous binder and are bonded thereby in the openings of the wheel. Diamond particles have a particle size up to 40 microns and the binder is resinified by prolonged heating.



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EV 511 024 001 US
SEPTEMBER 24 2004